

SZ5-M1-WX-XX – High-Power LED

Superior Efficacy and Lumen output with Small Form Factor

Z Power LED – Z5-M1

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SZ5-M1-WX-XX (Cool, Neutral, Warm)



Product Brief

Description

- The Z-Power series is designed for high flux output applications with high current operation capability.
- It incorporates state of the art SMD design and low thermal resistant material.
- The Z Power LED is ideal light sources for directional lighting applications such as Spot Lights, various outdoor applications, automotive lightings and high performance torches.

RoHS MacAdam 3-Step

Features and Benefits

- High Lumen Output and Efficacy
- Designed for high current operation
- Low Thermal Resistance
- Wide CCT range 2,600~7,000K
- High Color Quality, CRI Min. 80
- ANSI compliant Binning
- MacAdam 3 Step for Warm White

Key Applications

- Indoor lighting
- Outdoor lighting
- Automotive
- Architectural lighting
- Industrial lighting (High/Low bay)
- Portable Torch
- Home appliance

Part Number		CRI			
Fait Nulliger	Color	Min.	Тур.	Max.	Min
SZ5-M1-W0-00	Cool White	4700K	5300K	7000K	70
SZ5-M1-WN-00	Neutral White	3700K	4000K	4700K	70
SZ5-M1-WN-C8	Neutral White	3700K	4000K	4700K	80
SZ5-M1-WW-00	Warm White	2600K	3000K	3200K	68
SZ5-M1-WW-C8	Warm White	2600K	3000K	3700K	80
SZ5-M1-WW-C9	Warm White	2600K	3000K	3200K	90

Table 1. Product Selection Table



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Performance Characteristics

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Table 2. Product Selection, T_i=25°C, RH30%

Part Number	ССТ (К) [1]	Lui	Typical minous Flι Φ _ν ^[3] (Im)		-	pical Forw oltage (V _F)		CRI ^[5] , R _a
	Тур.	350mA	700mA	1200mA	350mA	700mA	1200mA	Min.
SZ5-M1-W0-00	5300	158	285	433	2.95	3.14	3.33	70
SZ5-M1-WN-00	4000	156	276	415	2.95	3.14	3.33	70
SZ5-M1-WN-C8	4000	142	253	382	2.95	3.14	3.33	80
SZ5-M1-WW-00	3000	148	265	403	2.95	3.14	3.33	68
SZ5-M1-WW-C8	3000	128	231	353	2.95	3.14	3.33	80
SZ5-M1-WW-C9	3000	105	188	286	2.95	3.14	3.33	90

Table 3. Product Selection, T_i=85°C

Part Number	ССТ (К) [1]	Lu	Typical minous Flux Φ _v ^[3] (Im)	[2]	-	rpical Forwar ⁄oltage (V _F) ^{[4}	
	Тур.	350mA	700mA	1200mA	350mA	700mA	1200mA
SZ5-M1-W0-00	5300	142	258	393	2.78	2.96	3.14
SZ5-M1-WN-00	4000	137	250	380	2.78	2.96	3.14
SZ5-M1-WN-C8	4000	126	229	349	2.78	2.96	3.14
SZ5-M1-WW-00	3000	141	239	364	2.78	2.96	3.14
SZ5-M1-WW-C8	3000	117	210	322	2.78	2.96	3.14
SZ5-M1-WW-C9	3000	95	153	232	2.78	2.96	3.14

Notes :

- (1) Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram. Color coordinate : ± 0.005 , CCT $\pm 5\%$ tolerance.
- (2) Seoul Semiconductor maintains a tolerance of \pm 7% on flux and power measurements.
- (3) $\Phi_{\rm V}$ is the total luminous flux output as measured with an integrating sphere.
- (4) Tolerance is $\pm 0.06V$ on forward voltage measurements.
- (5) Tolerance is ± 2.0 on CRI measurements.

Performance Characteristics

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Table 4. Absolute Maximum Ratings, T_j=25°C

Doromotor	Cumhal			Unit	
Parameter	Symbol	Min.	Тур.	Max.	Unit
Forward Current ^[1]	۱ _۶	-	-	1,500	mA
Peak Pulsed Forward Current [2]	۱ _۶	-	-	2,000	mA
Reverse Voltage	V _R	-	-	5	V
Power Dissipation	P _d	-	-	5.22	W
Junction Temperature	Tj	-	-	150	°C
Operating Temperature	T _{opr}	- 40	-	125	°C
Storage Temperature	T _{stg}	- 40	-	125	°C
Viewing angle	θ		118		degree
Thermal resistance (J to S) [3]	Rθ _{J-S}	-	4.5	-	K/W
ESD Sensitivity(HBM) ^[4]		Class	3A JESD22-A	114-E	

Notes :

- (1) At Junction Temperature 25 $^\circ\!\!\!\!^\circ C$ condition.
- (2) Pulse width \leq 10ms, duty cycle \leq 10% condition.
- (3) $R\theta_{J-S}$ is tested at 350mA.
- (4) The zener diode is included to protect the product from ESD.

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Fig 1. Color Spectrum, T_j=25°C



Fig 2. Typical Spatial Distribution



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Fig 3. Forward Voltage vs. Forward Current, $T_j=25$ °C





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Fig 5. Forward Current vs. CIE x, y Shift, $T_i=25$ °C



Fig 6. Junction Temp. vs. CIE x, y Shift, $I_F=350mA$





Fig 7. Relative Light Output vs. Junction Temperature, I_F=350mA

Fig 8. Relative Forward vs. Junction Temperature, I_F=350mA



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Characteristics Graph

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Fig 9. Maximum Forward Current vs. Ambient Temperature, T_j(max.)=150 $^{\circ}$ C, I_F =1,500mA



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Table 5. Bin Code description,	T _j =25℃, I _F =350mA
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	Lumir	ous Flux (I	lm)	Color	Typical Forward Voltage (V _F)		
Part Number	Bin Code	Min.	Max.	Chromaticity Coordinate	Bin Code	Min.	Max.
	V2	130	140		G	2.75	3.00
SZ5-M1-W0-00	V3	140	150	Refer to page.13	н	3.00	3.25
	W1	150	160	reler to page. To			
	W2	160	170		I	3.25	3.50
	V2	130	140		G	2.75	3.00
SZ5-M1-WN-00	V3	140	150	Refer to page.14	н	3.00	3.25
323-1017-0010-00	W1	150	160			5.00	5.25
	W2	160	170		I	3.25	3.50
	U3	109	118.5		G	2.75	3.00
SZ5-M1-WN-C8	V1	118.5	130	Refer to page.14	н	3.00	3.25
323-1011-0010-00	V2	130	140	Refer to page. 14		3.00	3.23
	V3	140	150		I	3.25	3.50
	V2	130	140		G	2.75	3.00
SZ5-M1-WW-00	V3	140	150	Refer to page.15	н	3.00	3.25
323-111-111-00	W1	150	160	Nelei to page. 10			
					I	3.25	3.50
	U3	109	118.5		G	2.75	3.00
SZ5-M1-WW-C8	V1	118.5	130	Refer to page.15	н	3.00	3.25
020-001-000-00	V2	130	140	Refer to page. 10			0.20
	V3	140	150		I	3.25	3.50
	U1	91	100		G	2.75	3.00
SZ5-M1-WW-C9	U2	100	109	Refer to page.15	н	3.00	3.25
	U3	109	118.5	Noter to page. 10			0.20
					I	3.25	3.50

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Table 6. Flux Bin Code description, $T_j=85$ °C

	Lur	minous Flux (Im)		
Bin Code	350r	nA	700	mA
Bin Code	Min.	Max.	Min.	Max.
U1	84	92	152	167
U2	92	100	167	182
U3	100	109	182	198
V1	109	119	193	205
V2	119	129	205	218
V3	129	138	218	240
W1	138	147	240	256
W2	147	156	256	272

Table 7. VF Bin Code description, T_j =85 °C

	For	ward Voltage (V _F)			
Bin Code	350	mA	700mA		
Bin Code	Min.	Max.	Min.	Max.	
G	2.60	2.82	2.77	3.02	
Н	2.82	3.06	3.02	3.27	
I	3.06	3.30	3.27	3.52	

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CIE Chromaticity Diagram (Cool white), $T_j = 25 \degree$, $I_F = 350 \text{mA}$

A	.0	A		A	2	A	.3	A	.4
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y
0.3028	0.3304	0.3115	0.3393	0.3041	0.3240	0.3126	0.3324	0.3055	0.3177
0.3041	0.3240	0.3126	0.3324	0.3055	0.3177	0.3136	0.3256	0.3068	0.3113
0.3126	0.3324	0.3210	0.3408	0.3136	0.3256	0.3216	0.3334	0.3146	0.3187
0.3115	0.3393	0.3205	0.3481	0.3126	0.3324	0.3210	0.3408	0.3136	0.3256
A	5	B		B	1	B	2	B	3
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y
0.3136	0.3256	0.3207	0.3462	0.3292	0.3539	0.3212	0.3389	0.3293	0.3461
0.3146	0.3187	0.3212	0.3389	0.3293	0.3461	0.3217	0.3316	0.3293	0.3384
0.3221	0.3261	0.3293	0.3461	0.3373	0.3534	0.3293	0.3384	0.3369	0.3451
0.3216	0.3334	0.3292	0.3539	0.3376	0.3616	0.3293	0.3461	0.3373	0.3534
B	4	B	5	C	0	C	1	C	2
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y
0.3217	0.3316	0.3293	0.3384	0.3376	0.3616	0.3463	0.3687	0.3373	0.3534
0.3222	0.3243	0.3294	0.3306	0.3373	0.3534	0.3456	0.3601	0.3369	0.3451
0.0004									
0.3294	0.3306	0.3366	0.3369	0.3456	0.3601	0.3539	0.3669	0.3448	0.3514
0.3293	0.3384	0.3369	0.3451	0.3463	0.3687	0.3539 0.3552	0.3669	0.3448	0.3514
0.3293		0.3369			0.3687				
0.3293 CIE x	0.3384 3 CIE y	0.3369 CIE x	0.3451 4 CIE y	0.3463	0.3687 5 CIE y				
0.3293 C	0.3384 3	0.3369 C	0.3451 4	0.3463 C	0.3687 5				
0.3293 CIE x 0.3456 0.3448	0.3384 3 CIE y	0.3369 CIE x	0.3451 4 CIE y 0.3451 0.3369	0.3463 CIE x	0.3687 5 CIE y				
0.3293 C CIE x 0.3456	0.3384 3 CIE y 0.3601	0.3369 CIE x 0.3369	0.3451 4 CIE y 0.3451	0.3463 CIE x 0.3448	0.3687 5 CIE y 0.3514				

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CIE Chromaticity Diagram (Neutral white), $T_j = 25 \degree$, $I_F = 350 \text{mA}$

D	0	D	1	D	2	D3		D4	
CIE x	CIE y								
0.3548	0.3736	0.3641	0.3804	0.3536	0.3646	0.3625	0.3711	0.3524	0.3555
0.3536	0.3646	0.3625	0.3711	0.3524	0.3555	0.3608	0.3616	0.3512	0.3465
0.3625	0.3711	0.3714	0.3775	0.3608	0.3616	0.3692	0.3677	0.3590	0.3521
0.3641	0.3804	0.3736	0.3874	0.3625	0.3711	0.3714	0.3775	0.3608	0.3616
D	5	E	0	E	1	E	2	E	3
CIE x	CIE y								
0.3608	0.3616	0.3736	0.3874	0.3869	0.3958	0.3714	0.3775	0.3842	0.3855
0.3590	0.3521	0.3714	0.3775	0.3842	0.3855	0.3692	0.3677	0.3813	0.3751
0.3670	0.3578	0.3842	0.3855	0.3970	0.3935	0.3813	0.3751	0.3934	0.3825
0.3692	0.3677	0.3869	0.3958	0.4006	0.4044	0.3842	0.3855	0.3970	0.3935
E	4	E	5						
CIE x	CIE y	CIE x	CIE y						
0.3692	0.3677	0.3813	0.3751	_					
0.3670	0.3578	0.3783	0.3646	-					
0.3783	0.3646	0.3898	0.3716	-					
0.3813	0.3751	0.3934	0.3825	-					

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CIE Chromaticity Diagram (Warm white), $T_j\!=\!25\,^\circ\!\!\mathbb{C},\,I_F\!=\!350mA$



C				_					
F(1		2		3	-	4
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y
0.3996	0.4015	0.4146	0.4089	0.396	0.3907	0.4104	0.3978	0.3925	0.3798
0.396	0.3907	0.4104	0.3978	0.3925	0.3798	0.4062	0.3865	0.3889	0.369
0.4104	0.3978	0.4248	0.4048	0.4062	0.3865	0.4198	0.3931	0.4017	0.3751
0.4146	0.4089	0.4299	0.4165	0.4104	0.3978	0.4248	0.4048	0.4062	0.3865
F	5		11		12	G13		G14	
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y
0.4062	0.3865	0.4299	0.4165	0.4261	0.4077	0.4223	0.3990	0.4185	0.3902
0.4017	0.3751	0.4261	0.4077	0.4223	0.3990	0.4185	0.3902	0.4147	0.3814
0.4147	0.3814	0.4324	0.4100	0.4284	0.4011	0.4243	0.3922	0.4203	0.3834
0.4198	0.3931	0.4365	0.4189	0.4324	0.4100	0.4284	0.4011	0.4243	0.3922
G2			22		23		24		31
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y
0.4365	0.4189	0.4324	0.4100	0.4284	0.4011	0.4243	0.3922	0.4430	0.4212
0.4324	0.4100	0.4284	0.4011	0.4243	0.3922	0.4203	0.3834	0.4387	0.4122
0.4387	0.4122	0.4345	0.4033	0.4302	0.3943	0.4259	0.3853	0.4451	0.4145
0.4430	0.4212	0.4387	0.4122	0.4345	0.4033	0.4302	0.3943	0.4496	0.4236
G3	32	G	33	G	34	G	41	G	42
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y
0.4387	0.4122	0.4345	0.4033	0.4302	0.3943	0.4496	0.4236	0.4451	0.4145
0.4345	0.4033	0.4302	0.3943	0.4259	0.3853	0.4451	0.4145	0.4406	0.4055
0.4406	0.4055	0.4361	0.3964	0.4316	0.3873	0.4515	0.4168	0.4468	0.4077
0.4451	0.4145	0.4406	0.4055	0.4361	0.3964	0.4562	0.4260	0.4515	0.4168
G4		G		H		H		H	
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y
0.4406	0.4055	0.4361	0.3964	0.4625	0.4275	0.4575	0.4182	0.4526	0.4090
0.4361	0.3964	0.4316	0.3873	0.4575	0.4182	0.4526	0.4090	0.4477	0.3998
0.4420		0.4510	0.0070						
0.4468	0.3985	0.4373	0.3893	0.4515	0.4168	0.4468	0.4077	0.4420	0.3985
	0.4077	0.4373 0.4420	0.3893 0.3985	0.4515 0.4562	0.4168 0.4260		0.4077	0.4420 0.4468	0.4077
0.4400 H1	0.4077	0.4373 0.4420	0.3893	0.4515 0.4562	0.4168 0.4260 22	0.4468	0.4168	0.4420 0.4468	
	0.4077	0.4373 0.4420	0.3893 0.3985	0.4515 0.4562	0.4168 0.4260 22	0.4468 0.4515	0.4168	0.4420 0.4468	0.4077
H1	0.4077 4	0.4373 0.4420 H2	0.3893 0.3985 21	0.4515 0.4562	0.4168 0.4260	0.4468 0.4515 H:	0.4168 23	0.4420 0.4468 CIE x 0.4534	0.4077 24
H1 CIE x 0.4477 0.4428	0.4077 4 CIE y 0.3998 0.3906	0.4373 0.4420 CIE x 0.4687 0.4636	0.3893 0.3985 21 CIE y 0.4289 0.4197	0.4515 0.4562 H: CIE x 0.4636 0.4585	0.4168 0.4260 22 CIE y 0.4197 0.4104	0.4468 0.4515 CIE x 0.4585 0.4534	0.4168 23 CIE y 0.4104 0.4012	0.4420 0.4468 CIE x 0.4534 0.4483	0.4077 24 CIE y 0.4012 0.3919
H1 CIE x 0.4477	0.4077 4 CIE y 0.3998 0.3906 0.3893	0.4373 0.4420 CIE x 0.4687 0.4636 0.4575	0.3893 0.3985 21 CIE y 0.4289 0.4197 0.4182	0.4515 0.4562 CIE x 0.4636 0.4585 0.4526	0.4168 0.4260 22 CIE y 0.4197 0.4104 0.4090	0.4468 0.4515 CIE x 0.4585 0.4534 0.4477	0.4168 23 CIE y 0.4104 0.4012 0.3998	0.4420 0.4468 CIE x 0.4534	0.4077 24 CIE y 0.4012
H1 CIE x 0.4477 0.4428	0.4077 4 CIE y 0.3998 0.3906	0.4373 0.4420 CIE x 0.4687 0.4636	0.3893 0.3985 21 CIE y 0.4289 0.4197	0.4515 0.4562 H: CIE x 0.4636 0.4585	0.4168 0.4260 22 CIE y 0.4197 0.4104	0.4468 0.4515 CIE x 0.4585 0.4534	0.4168 23 CIE y 0.4104 0.4012	0.4420 0.4468 CIE x 0.4534 0.4483	0.4077 24 CIE y 0.4012 0.3919
H1 CIE x 0.4477 0.4428 0.4373 0.4420 H3	0.4077 4 CIE y 0.3998 0.3906 0.3893 0.3985	0.4373 0.4420 CIE x 0.4687 0.4636 0.4575 0.4625	0.3893 0.3985 21 CIE y 0.4289 0.4197 0.4182 0.4275 32	0.4515 0.4562 CIE x 0.4636 0.4585 0.4526 0.4575	0.4168 0.4260 22 CIE y 0.4197 0.4104 0.4090 0.4182 33	0.4468 0.4515 CIE x 0.4585 0.4534 0.4534 0.4477 0.4526	0.4168 23 CIE y 0.4104 0.4012 0.3998 0.4090 34	0.4420 0.4468 CIE x 0.4534 0.4483 0.4483 0.4428 0.4477	0.4077 24 CIE y 0.4012 0.3919 0.3906
H1 CIE x 0.4477 0.4428 0.4373 0.4420	0.4077 4 CIE y 0.3998 0.3906 0.3893 0.3985	0.4373 0.4420 CIE x 0.4687 0.4636 0.4575 0.4625	0.3893 0.3985 21 CIE y 0.4289 0.4197 0.4182 0.4275	0.4515 0.4562 CIE x 0.4636 0.4585 0.4526 0.4575	0.4168 0.4260 22 CIE y 0.4197 0.4104 0.4090 0.4182	0.4468 0.4515 CIE x 0.4585 0.4534 0.4477 0.4526	0.4168 23 CIE y 0.4104 0.4012 0.3998 0.4090	0.4420 0.4468 CIE x 0.4534 0.4483 0.4428 0.4477	0.4077 24 CIE y 0.4012 0.3919 0.3906 0.3998
H1 CIE x 0.4477 0.4428 0.4373 0.4420 H3 CIE x 0.4750	0.4077 4 CIE y 0.3998 0.3906 0.3893 0.3985 1 CIE y 0.4304	0.4373 0.4420 CIE x 0.4687 0.4636 0.4575 0.4625 H: CIE x 0.4697	0.3893 0.3985 21 CIE y 0.4289 0.4197 0.4197 0.4275 0.4275 32 CIE y 0.4211	0.4515 0.4562 CIE x 0.4636 0.4585 0.4526 0.4575 H CIE x 0.4644	0.4168 0.4260 22 CIE y 0.4197 0.4104 0.4090 0.4182 33 CIE y 0.4118	0.4468 0.4515 CIE x 0.4585 0.4534 0.4534 0.4526 H: CIE x 0.4591	0.4168 23 CIE y 0.4104 0.4012 0.3998 0.4090 34 CIE y 0.4025	0.4420 0.4468 CIE x 0.4534 0.4483 0.4483 0.4428 0.4477 H4 CIE x 0.4810	0.4077 24 CIE y 0.4012 0.3919 0.3906 0.3998 41 CIE y 0.4319
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Mechanical Dimensions

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Notes :

- (1) All dimensions are in millimeters.
- (2) Scale : none
- (3) Undefined tolerance is $\pm 0.1 \text{mm}$



SZ5-M1-WX-XX – High-Power LED

Emitter Tape & Reel Packaging





Product Nomenclature

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Table 8. Part Numbering System : X₁X₂X₃ - X₄X₅ - X₆X₇ - X₈X₉

Part Number Code	Description	Part Number	Value
X ₁	Company	S	
X ₂	Z-Power LED series number	Z	
X ₃	PKG series	5	
X ₄	PKG series	М	M series
X ₅	Revision number	1	New version
X ₆ X ₇	Color Specification	W0	Pure white
		WN	Neutral white
		WW	Warm white
X ₈ X ₉	Color Specification	C8	CRI (min.) 80
		C9	CRI (min.) 90
		00	The others

Lot Number Code	Description	
Y ₁	Year	
Y ₂	Month	
Y ₃	Day	
Y ₄	Production area	
Y ₅	Mass order	
Y ₆	Taping number	
Y ₇	Reel number	
Y ₈	Internal management number	

Recommended Solder Pad

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Recommended PCB Solder Pad

Recommended Stencil Pattern

Notes :

- (1) All dimensions are in millimeters.
- (2) Scale : none
- (3) This drawing without tolerances are for reference only.
- (4) Undefined tolerance is $\pm 0.1 \text{mm.}$

Reflow Soldering Characteristics



Table 10.

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average ramp-up rate (Tsmax to Tp)	3° C/second max.	3° C/second max.
Preheat - Temperature Min (Tsmin) - Temperature Max (Tsmax) - Time (Tsmin to Tsmax) (ts)	100 °C 150 °C 60-120 seconds	150 ℃ 200 ℃ 60-180 seconds
Time maintained above: - Temperature (TL) - Time (tL)	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak Temperature (Tp)	215℃	260 ℃
Time within 5°C of actual Peak Temperature (tp)2	10-30 seconds	20-40 seconds
Ramp-down Rate	6 °C/second max.	6 °C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

Caution

- (1) Reflow soldering is recommended not to be done more than two times. In the case of more than 24 hours passed soldering after first, LEDs will be damaged.
- (2) Repairs should not be done after the LEDs have been soldered. When repair is unavoidable, suitable tools must be used.
- (3) Die slug is to be soldered.
- (4) When soldering, do not put stress on the LEDs during heating.
- (5) After soldering, do not warp the circuit board.

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SZ5-M1-WX-XX – High-Power LED

Handling of Silicone Resin for LEDs

(1) During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound.



- (2) In general, LEDs should only be handled from the side. By the way, this also applies to LEDs without a silicone sealant, since the surface can also become scratched.
- (3) When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the surface of the resin must be prevented. This is assured by choosing a pick and place nozzle which is larger than the LED's reflector area.
- (4) Silicone differs from materials conventionally used for the manufacturing of LEDs. These conditions must be considered during the handling of such devices. Compared to standard encapsulants, silicone is generally softer, and the surface is more likely to attract dust. As mentioned previously, the increased sensitivity to dust requires special care during processing. In cases where a minimal level of dirt and dust particles cannot be guaranteed, a suitable cleaning solution must be applied to the surface after the soldering of components.
- (5) Seoul Semiconductor suggests using isopropyl alcohol for cleaning. In case other solvents are used, it must be assured that these solvents do not dissolve the package or resin. Ultrasonic cleaning is not recommended. Ultrasonic cleaning may cause damage to the LED.
- (6) Please do not mold this product into another resin (epoxy, urethane, etc) and do not handle this product with acid or sulfur material in sealed space.
- (7) Avoid leaving fingerprints on silicone resin parts.



Precaution for Use

(1) Storage

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To avoid the moisture penetration, we recommend storing Z5 Series LEDs in a dry box with a desiccant . The recommended storage temperature range is 5 $^\circ$ to 30 $^\circ$ and a maximum humidity of RH50%.

(2) Use Precaution after Opening the Packaging

Use proper SMD techniques when the LED is to be soldered dipped as separation of the lens may affect the light output efficiency.

Pay attention to the following:

- a. Recommend conditions after opening the package
 - Sealing / Temperature : 5 ~ 40 $^\circ\!\! C$ Humidity : less than RH30%
- b. If the package has been opened more than 1 year (MSL 2) or the color of

the desiccant changes, components should be dried for 10-12hr at 60 $\pm5\,^\circ{\rm C}$

(3) Do not apply mechanical force or excess vibration during the cooling process to normal temperature after soldering.

(4) Do not rapidly cool device after soldering.

(5) Components should not be mounted on warped (non coplanar) portion of PCB.

(6) Radioactive exposure is not considered for the products listed here in.

(7) Gallium arsenide is used in some of the products listed in this publication. These products are dangerous if they are burned or shredded in the process of disposal. It is also dangerous to drink the liquid or inhale the gas generated by such products when chemically disposed of.

(8) This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When washing is required, IPA (Isopropyl Alcohol) should be used.

(9) When the LEDs are in operation the maximum current should be decided after measuring the package temperature.

(10) LEDs must be stored properly to maintain the device. If the LEDs are stored for 3 months or more after being shipped from Seoul Semiconductor. A sealed container with a nitrogen atmosphere should be used for storage.

(11) The appearance and specifications of the product may be modified for improvement without notice.

(12) Long time exposure of sunlight or occasional UV exposure will cause lens discoloration.



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Precaution for Use

(13) VOCs (Volatile organic compounds) emitted from materials used in the construction of fixtures ca n penetrate silicone encapsulants of LEDs and discolor when exposed to heat and photonic energy. T he result can be a significant loss of light output from the fixture. Knowledge of the properties of the m aterials selected to be used in the construction of fixtures can help prevent these issues.

(14) The slug is electrically isolated.

(15) Attaching LEDs, do not use adhesives that outgas organic vapor.

(16) The driving circuit must be designed to allow forward voltage only when it is ON or OFF. If the rev erse voltage is applied to LED, migration can be generated resulting in LED damage.

(17) LEDs are sensitive to Electro-Static Discharge (ESD) and Electrical Over Stress (EOS). Below is a list of suggestions that Seoul Semiconductor purposes to minimize these effects.

a. ESD (Electro Static Discharge)

Electrostatic discharge (ESD) is the defined as the release of static electricity when two objects come into contact. While most ESD events are considered harmless, it can be an expensive problem in many industrial environments during production and storage. The damage from ESD to an LEDs may cause the product to demonstrate unusual characteristics such as:

- Increase in reverse leakage current lowered turn-on voltage
- Abnormal emissions from the LED at low current

The following recommendations are suggested to help minimize the potential for an ESD event. One or more recommended work area suggestions:

- Ionizing fan setup
- ESD table/shelf mat made of conductive materials
- ESD safe storage containers

One or more personnel suggestion options:

- Antistatic wrist-strap
- Antistatic material shoes
- Antistatic clothes

Environmental controls:

- Humidity control (ESD gets worse in a dry environment)



Precaution for Use

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b. EOS (Electrical Over Stress)

Electrical Over-Stress (EOS) is defined as damage that may occur when an electronic device is subjected to a current or voltage that is beyond the maximum specification limits of the device. The effects from an EOS event can be noticed through product performance like:

- Changes to the performance of the LED package

(If the damage is around the bond pad area and since the package is completely encapsulated the package may turn on but flicker show severe performance degradation.)

- Changes to the light output of the luminaire from component failure
- Components on the board not operating at determined drive power

Failure of performance from entire fixture due to changes in circuit voltage and current across total circuit causing trickle down failures. It is impossible to predict the failure mode of every LED exposed to electrical overstress as the failure modes have been investigated to vary, but there are some common signs that will indicate an EOS event has occurred:

- Damaged may be noticed to the bond wires (appearing similar to a blown fuse)
- Damage to the bond pads located on the emission surface of the LED package
- (shadowing can be noticed around the bond pads while viewing through a microscope)
- Anomalies noticed in the encapsulation and phosphor around the bond wires.
- This damage usually appears due to the thermal stress produced during the EOS event.

c. To help minimize the damage from an EOS event Seoul Semiconductor recommends utilizing:

- A surge protection circuit
- An appropriately rated over voltage protection device
- A current limiting device



Company Information

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Company Information

Seoul Semiconductor (www.SeoulSemicon.com) manufacturers and packages a wide selection of light emitting diodes (LEDs) for the automotive, general illumination/lighting, Home appliance, signage and back lighting markets. The company is the world's fifth largest LED supplier, holding more than 10,000 patents globally, while offering a wide range of LED technology and production capacity in areas such as "nPola", "Acrich", the world's first commercially produced AC LED, and "Acrich MJT - Multi-Junction Technology" a proprietary family of high-voltage LEDs.

The company's broad product portfolio includes a wide array of package and device choices such as Acrich and Acirch2, high-brightness LEDs, mid-power LEDs, side-view LEDs, and through-hole type LEDs as well as custom modules, displays, and sensors.

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